# Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: http://www.renesas.com

April 1<sup>st</sup>, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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# RJK0329DPB

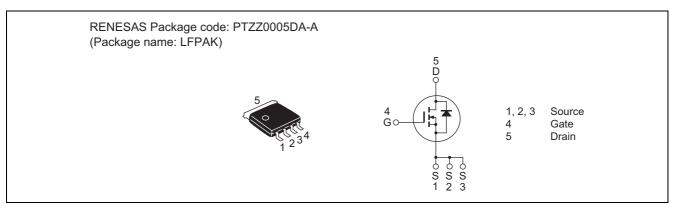
Silicon N Channel Power MOS FET Power Switching

> REJ03G1638-0400 Rev.4.00 Apr 10, 2008

### Features

- High speed switching
- Capable of 4.5 V gate drive
- Low drive current
- High density mounting
- Low on-resistance
  - $R_{DS(on)} = 1.8 \text{ m}\Omega \text{ typ.} (at V_{GS} = 10 \text{ V})$
- Pb-free

### Outline



## **Absolute Maximum Ratings**

			$(Ta = 25^{\circ}C)$
Item	Symbol	Ratings	Unit
Drain to source voltage	V <sub>DSS</sub>	30	V
Gate to source voltage	V <sub>GSS</sub>	±20	V
Drain current	ID	55	A
Drain peak current	Note1 I <sub>D(pulse)</sub>	220	A
Body-drain diode reverse drain current	I <sub>DR</sub>	55	A
Avalanche current	I <sub>AP</sub> Note 2	25	A
Avalanche energy	E <sub>AR</sub> Note 2	62.5	mJ
Channel dissipation	Pch <sup>Note3</sup>	60	W
Channel to Case Thermal Resistance	θch-C	2.08	°C/W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	۵°C

Notes: 1.  $PW \leq 10 \ \mu s, \ duty \ cycle \leq 1\%$ 

2. Value at Tch = 25°C, Rg  $\geq$  50  $\Omega$ 

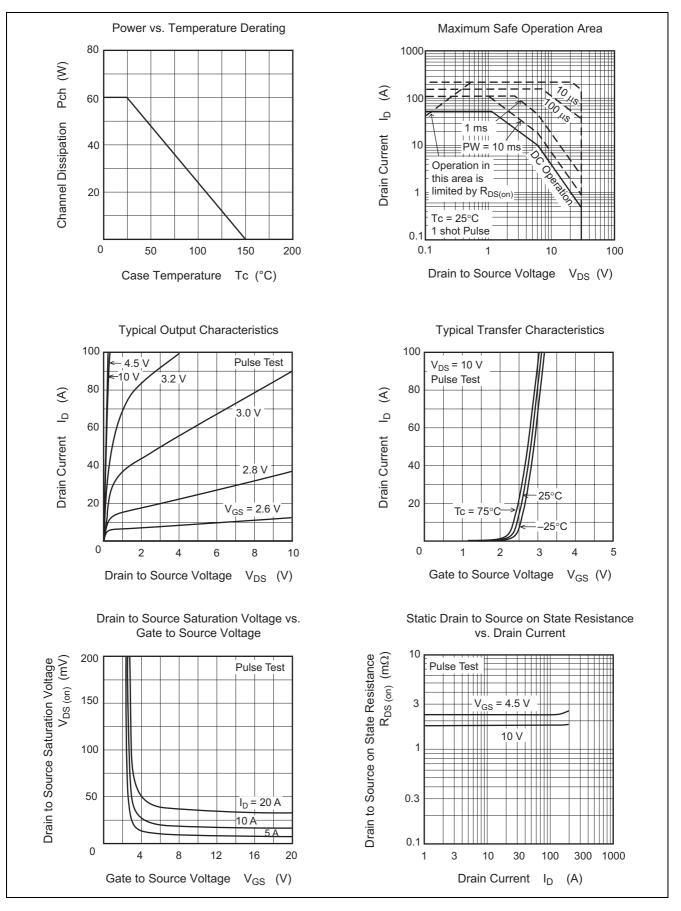
3. Tc = 25°C

## **Electrical Characteristics**

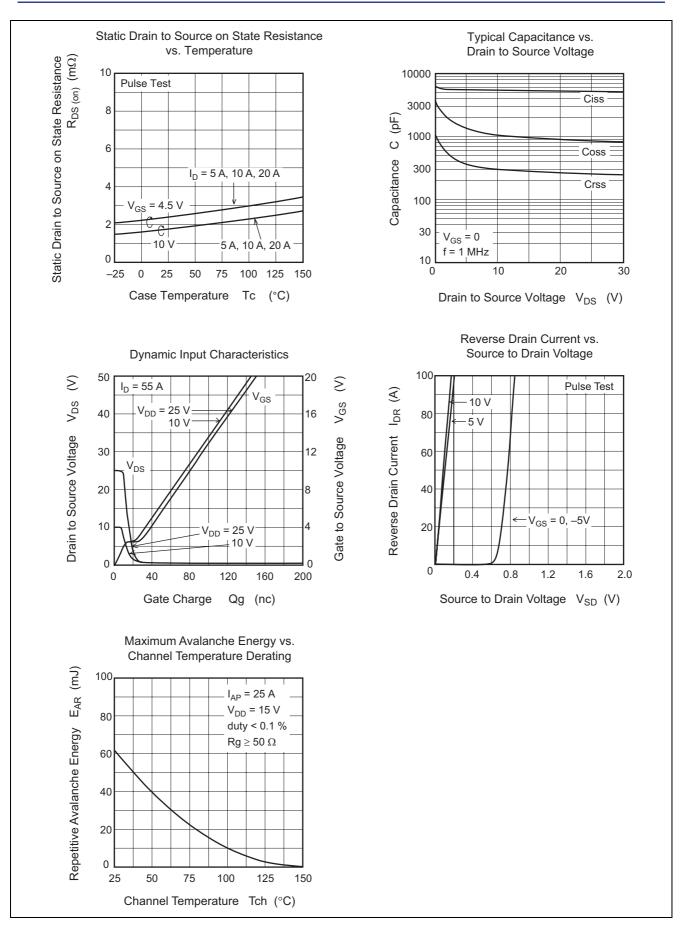
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V <sub>(BR)DSS</sub>	30	_	—	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source leak current	I <sub>GSS</sub>		_	±0.1	μΑ	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I <sub>DSS</sub>	_	—	1	μΑ	$V_{DS} = 30 V, V_{GS} = 0$
Gate to source cutoff voltage	V <sub>GS(off)</sub>	1.2	—	2.5	V	$V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA}$
Static drain to source on state	R <sub>DS(on)</sub>	_	1.8	2.3	mΩ	$I_D = 27.5 \text{ A}, V_{GS} = 10 \text{ V}^{\text{Note4}}$
resistance	R <sub>DS(on)</sub>	_	2.4	3.4	mΩ	$I_D = 27.5 \text{ A}, V_{GS} = 4.5 \text{ V}^{Note4}$
Forward transfer admittance	y <sub>fs</sub>	_	100	—	S	$I_D = 27.5 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note4}}$
Input capacitance	Ciss		5330	_	pF	$V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 0,$ f = 1 MHz
Output capacitance	Coss		980	_	pF	
Reverse transfer capacitance	Crss		295		pF	
Gate Resistance	Rg		0.5		Ω	
Total gate charge	Qg		35		nC	$V_{DD} = 10 \text{ V}, V_{GS} = 4.5 \text{ V},$ $I_D = 55 \text{ A}$
Gate to source charge	Qgs		13	_	nC	
Gate to drain charge	Qgd		7.3		nC	
Turn-on delay time	t <sub>d(on)</sub>		7.7		ns	
Rise time	tr		4.0		ns	
Turn-off delay time	t <sub>d(off)</sub>		59		ns	
Fall time	t <sub>f</sub>		6.8		ns	
Body-drain diode forward voltage	V <sub>DF</sub>	_	0.78	1.02	V	$I_F = 55 \text{ A}, V_{GS} = 0^{\text{Note4}}$
Body–drain diode reverse recovery time	t <sub>rr</sub>	_	40	—	ns	$I_{F} = 55 \text{ A}, V_{GS} = 0$ $di_{F}/dt = 100 \text{ A}/\mu s$
Body–drain diode reverse recovery charge	Qrr	_	42	_	nC	1

Notes: 4. Pulse test

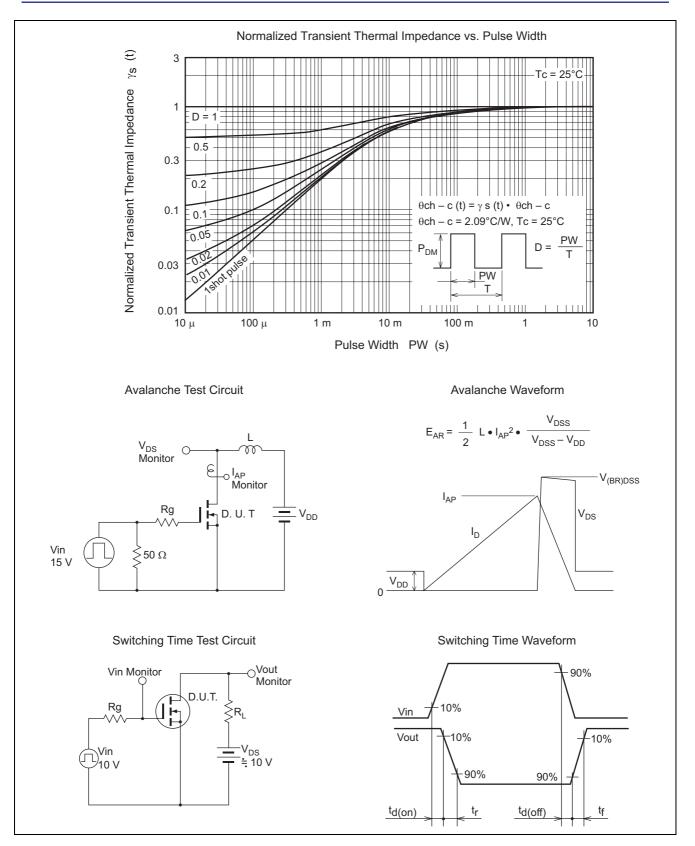
#### **Main Characteristics**



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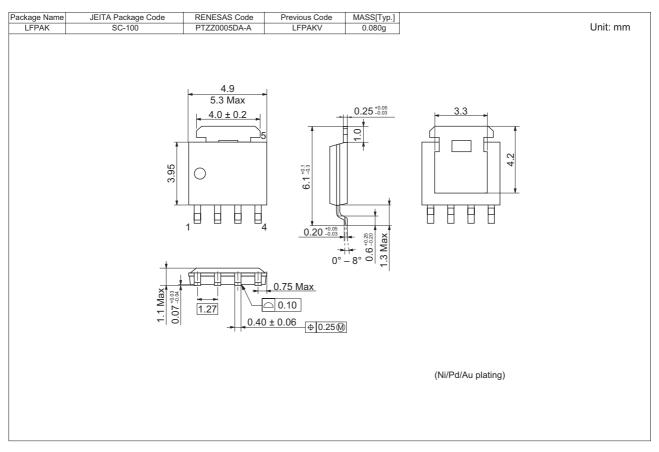


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### **Package Dimensions**



### **Ordering Information**

Part No.	Quantity	Shipping Container
RJK0329DPB-00-J0	2500 pcs	Taping

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